V62C1804096 512K X 8, CMOS STATIC RAM

PRELIMINARY

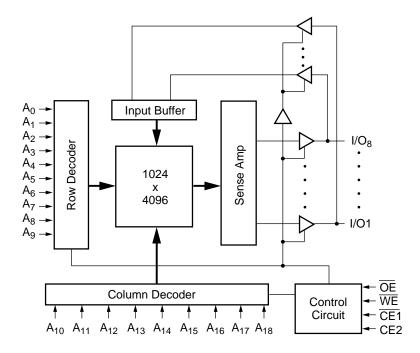
Features

- High-speed: 85, 100 ns
- Ultra low standby current of 2µA (max.)
- Fully static operation
- All inputs and outputs directly compatible
- Three state outputs
- Ultra low data retention current (V_{CC} = 1.0V)
- Operating voltage: 1.8V–2.3V
- Packages
 - 36-Ball CSP BGA (8mm x 10mm)

Description

The V62C1804096 is a very low power CMOS static RAM organized as 524,288 words by 8 bits. Easy memory expansion is provided by an active LOW CE1, and active HIGH CE2, an active LOW \overline{OE} , and three static I/O's. This device has an automatic power-down mode feature when deselected.

Functional Block Diagram



Device Usage Chart

Operating Temperature	Package Outline	Access 1	Гime (ns)	Po	wer	Temperature
Range	В	85	100	L	LL	Mark
0°C to 70 °C	•	•	•	•	•	Blank
-40°C to +85°C	•	•	•		•	I

Pin Descriptions

A₀–A₁₈ Address Inputs

These 19 address inputs select one of the 512K x 8 bit segments in the RAM.

CE₁, CE₂ Chip Enable Inputs

 \overline{CE}_1 is active LOW and \overline{CE}_2 is active HIGH. Both chip enables must be active to read from or write to the device. If either chip enable is not active, the device is deselected and is in a standby power mode. The I/O pins will be in the high-impedance state when deselected.

OE Output Enable Input

The Output Enable input is active LOW. With chip enabled, when OE is LOW and WE HIGH, data of the selected memory location will be available on the I/O pins. When OE is HIGH, the I/O pins will be in the high impedance state.

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WE Write Enable Input

The write enable input is active LOW and controls read and write operations. With the chip enabled, when \overline{WE} is HIGH and \overline{OE} is LOW, output data will be present at the I/O pins; when \overline{WE} is LOW and \overline{OE} is HIGH, the data present on the I/O pins will be written into the selected memory locations.

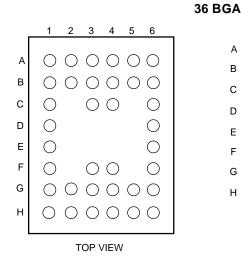
I/O₁–I/O₈ Data Input and Data Output Ports

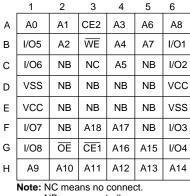
These 8 bidirectional ports are used to read data from and write data into the RAM.

V_{CC} Power Supply

GND Ground

Pin Configurations (Top View)



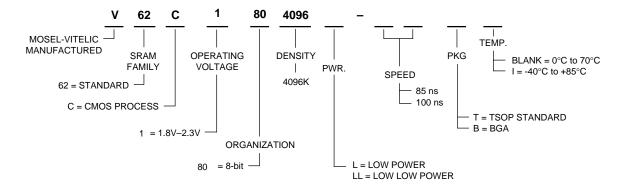


NB means no ball.

TOP VIEW

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Part Number Information



Absolute Maximum Ratings (1)

Symbol	Parameter	Commercial	Industrial	Units
V _{CC}	Supply Voltage	-0.5 to + V_{CC} + 0.5	-0.5 to + V _{CC} + 0.5	V
V _N	Input Voltage	-0.5 to + V_{CC} + 0.5	-0.5 to + V _{CC} + 0.5	V
V _{DQ}	Input/Output Voltage Applied	V _{CC} + 0.3	V _{CC} + 0.3	V
T _{BIAS}	Temperature Under Bias	-10 to +125	-65 to +135	°C
T _{STG}	Storage Temperature	-55 to +125	-65 to +150	°C

NOTE:

1. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Capacitance*

$T_{A} = 25^{\circ}C, f$	= 1.0MHz
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Symbol	Parameter	Conditions	Max.	Unit
C _{IN}	Input Capacitance	$V_{IN} = 0V$	6	pF
C _{OUT}	Output Capacitance	$V_{I/O} = 0V$	8	pF

NOTE:

1. This parameter is guaranteed and not tested.

Truth Table

Mode		CE2	OE	WE	I/O Operation
Standby	Н	Х	Х	х	High Z
Standby	Х	L	Х	х	High Z
Output Disable	L	н	Н	Н	High Z
Read	L	н	L	Н	D _{OUT}
Write	L	н	Х	L	D _{IN}

NOTE:

X = Don't Care, L = LOW, H = HIGH

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Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V _{IL}	Input LOW Voltage ^(1,2)		-0.3	—	0.4	V
V _{IH}	Input HIGH Voltage ⁽¹⁾		1.6	_	V _{CC} +0.3	V
Ι _{IL}	Input Leakage Current	$V_{CC} = Max$, $V_{IN} = 0V$ to V_{CC}	—	_	1	μΑ
I _{OL}	Output Leakage Current	$V_{CC} = Max, \overline{CE}_1 = V_{IH}, V_{OUT} = 0V \text{ to } V_{CC}$	—	_	1	μΑ
V _{OL}	Output LOW Voltage	$V_{CC} = Min, I_{OL} = 2mA$	_	_	0.4	V
V _{OH}	Output HIGH Voltage	$V_{CC} = Min, I_{OH} = -0.5mA$	V _{CC} -0.4		—	V

DC Electrical Characteristics (over all temperature ranges, $V_{CC} = 1.8V-2.3V$)

Symbol	Parameter	Comm. ⁽³⁾	Ind. ⁽³⁾	Units	
I _{CC1}	Average Operating Current, $\overline{CE}_1 = V_{IL}$, $CE_2 = V_{CC} - 0.2$, Output Open,		25	30	mA
		f = 1 MHz	2	3	
I _{SB}	TTL Standby Current	L	0.4	0.5	mA
	$\overline{CE}_1 \ge V_{IH}$, $CE_2 \le V_{IL}$, $V_{CC} = Max.$, $f = 0$	LL	0.3	0.3	
I _{SB1}	CMOS Standby Current, $\overline{CE}_1 \\ \\ S V_{CC} - 0.2V$, $CE_2 \\ \\ \delta 0.2V$,	L	5	7	μA
	$V_{IN} \ge V_{CC} - 0.2V \text{ or } V_{IN} \le 0.2V, V_{CC} = Max., f = 0$	LL	2	3	

NOTES:

1. These are absolute values with respect to device ground and all overshoots due to system or tester noise are included.

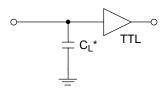
2. V_{IL} (Min.) = -3.0V for pulse width < $t_{RC}/2$.

3. Maximum value.

AC Test Conditions

Input Pulse Levels	0 to 1.6V
Input Rise and Fall Times	5 ns
Timing Reference Levels	0.9V
Output Load	see below

AC Test Loads and Waveforms



 $C_L = 30pF + 1TTL Load$

* Includes scope and jig capacitance

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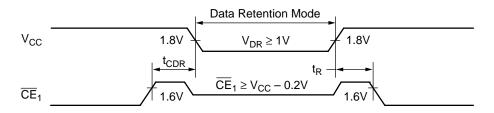
Data Retention Characteristics

Symbol	Parameter		Power	Min.	Typ. ⁽²⁾	Max.	Units
V _{DR}	$\label{eq:V_CC} \begin{array}{l} V_{CC} \text{ for Data Retention} \\ \overline{CE}_1 \geq V_{CC} - 0.2V, \ CE_2 < 0.2V, \ V_{IN} \geq V_{CC} - 0.2V, \\ \text{ or } V_{IN} \leq 0.2V \end{array}$			1.0	_	2.3	V
I _{CCDR}	Data Retention Current	Com'l	L	_	1	3	μΑ
	$\overline{CE}_1 \ge V_{DR} - 0.2V, CE_2 < 0.2V, V_{IN} \ge V_{CC} - 0.2V,$ or $V_{IN} \le 0.2V, V_{DR} = 1.0V$		LL	_	0.5	1.5	
		Ind.	L	_	—	5	
			LL	_	—	2	
t _{CDR}	Chip Deselect to Data Retention Time			0	—	_	ns
t _R	Operation Recovery Time (see Retention Waveform)		t _{RC} ⁽¹⁾	_		ns

NOTES:

1. t_{RC} = Read Cycle Time 2. T_A = +25°C.

Low V_{CC} Data Retention Waveform (1) (\overline{CE}_1 Controlled)



Key to Switching Waveforms

WAVEFORM	INPUTS	OUTPUTS
	MUST BE STEADY	WILL BE STEADY
	MAY CHANGE FROM H TO L	WILL BE CHANGING FROM H TO L
	MAY CHANGE FROM L TO H	WILL BE CHANGING FROM L TO H
	DON'T CARE: ANY CHANGE PERMITTED	CHANGING: STATE UNKNOWN
$\mathbb{P}\mathbb{C}$	DOES NOT APPLY	CENTER LINE IS HIGH IMPEDANCE "OFF" STATE

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AC Electrical Characteristics

(over all temperature ranges)

Read Cycle

Parameter		85		10	00	
Name	Parameter	Min.	Max.	Min.	Max.	Unit
^t RC	Read Cycle Time	85	_	100	_	ns
t _{AA}	Address Access Time	—	85	_	100	ns
t _{ACS1}	Chip Enable Access Time	—	85	_	100	ns
t _{ACS2}	Chip Enable Access Time	—	85	-	100	ns
t _{OE}	Output Enable to Output Valid	—	85	-	40	ns
t _{CLZ1}	Chip Enable to Output in Low Z	10	-	15	-	ns
t _{CLZ2}	Chip Enable to Output in Low Z	10	-	15	_	ns
^t OLZ	Output Enable to Output in Low Z	5	-	10	_	ns
t _{CHZ}	Chip Disable to Output in High Z	_	30	_	35	ns
t _{OHZ}	Output Disable to Output in High Z		30	_	35	ns
^t он	Output Hold from Address Change	10	_	10	_	ns

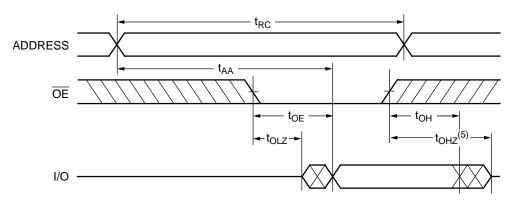
Write Cycle

Parameter		85		100			
Name	Parameter	Min.	Max.	Min.	Max.	Unit	
^t wc	Write Cycle Time	85	_	70	_	ns	
t _{CW}	Chip Enable to End of Write	70	—	60	—	ns	
t _{AS}	Address Setup Time	0	_	0	_	ns	
t _{AW}	Address Valid to End of Write	70	—	60	—	ns	
t _{WP}	Write Pulse Width	60	—	50	—	ns	
t _{WR}	Write Recovery Time	5	—	5	_	ns	
^t wHz	Write to Output High-Z	—	25	—	30	ns	
t _{DW}	Data Setup to End of Write	40	_	45	_	ns	
^t DH	Data Hold from End of Write	0	_	0	_	ns	

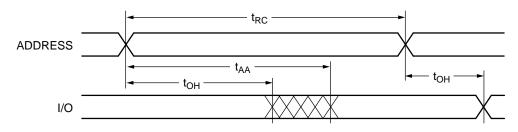
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Switching Waveforms (Read Cycle)

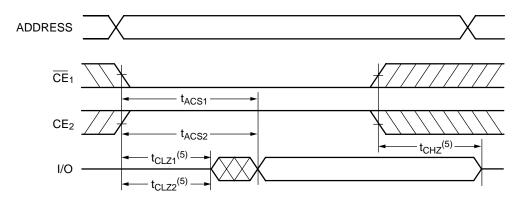
Read Cycle 1^(1, 2)



Read Cycle 2^(1, 2, 4)



Read Cycle 3^(1, 3, 4)



NOTES:

- 1.
- 2.

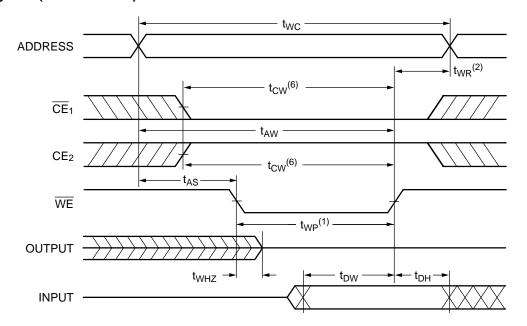
 $\frac{\overline{WE}}{\overline{CE}_1} = V_{IH}.$ $\overline{CE}_1 = V_{IL} \text{ and } CE_2 = V_{IH}.$ Address valid prior to or coincident with \overline{CE}_1 transition LOW and/or CE_2 transition HIGH. 3.

- 4. $\overline{OE} = V_{IL}$.
- Transition is measured \pm 500mV from steady state with C_L = 5pF. This parameter is guaranteed and not 100% tested. 5.

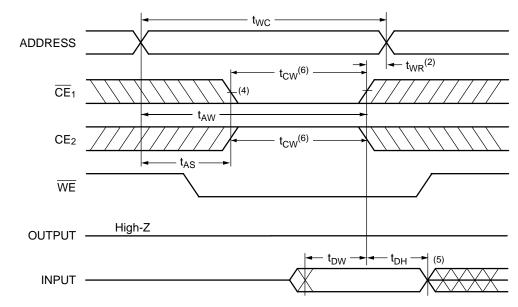
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Switching Waveforms (Write Cycle)

Write Cycle 1 (WE Controlled)⁽⁴⁾



Write Cycle 2 (CE Controlled)⁽⁴⁾

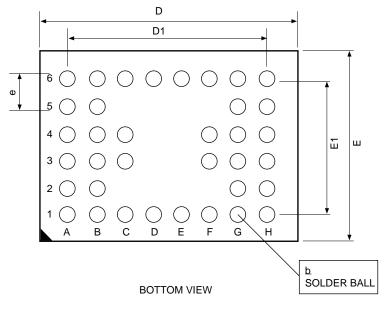


NOTES:

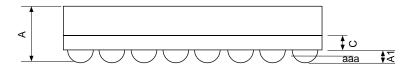
- The internal write time of the memory is defined by the overlap of CE₁ and CE₂ active and WE low. All signals must be active to initiate and any one signal can terminate a write by going inactive. The data input setup and hold timing should be referenced to the second transition edge of the signal that terminates the write.
- 2. t_{WR} is measured from the earlier of \overline{CE}_1 or \overline{WE} going high, or CE_2 going LOW at the end of the write cycle.
- 3. During this period, I/O pins are in the output state so that the input signals of opposite phase to the outputs must not be applied.
- 4. $\overline{OE} = V_{IL}$ or V_{IH} . However it is recommended to keep \overline{OE} at V_{IH} during write cycle to avoid bus contention.
- 5. If \overline{CE}_1 is LOW and CE_2 is HIGH during this period, I/O pins are in the output state. Then the data input signals of opposite phase to the outputs must not be applied to them.
- 6. t_{CW} is measured from \overline{CE}_1 going low or CE_2 going HIGH to the end of write.

Package Diagrams

36 Ball—8x10 BGA



SYMBOL	UNIT.MM
А	1.05+0.15
A1	0.25±0.05
b	0.35±.0.05
с	0.30(TYP)
D	10.00±0.10
D1	5.25
E	8.00±0.10
E1	3.75
е	0.75TYP
aaa	0.10



SIDE VIEW

V62C1804096

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